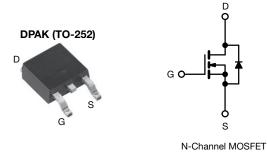
## SiHD690N60E

Vishay Siliconix



**E Series Power MOSFET** 



PRODUCT SUMMARY		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	65	50
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.60
Q <sub>g</sub> max. (nC)	1	2
Q <sub>gs</sub> (nC)	(	3
Q <sub>gd</sub> (nC)	:	3
Configuration	Sin	gle

#### FEATURES

- 4<sup>th</sup> generation E series technology
- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C<sub>o(er)</sub>)
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	DPAK (TO-252)
Lead (Pb)-free and halogen-free	SiHD690N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V <sub>DS</sub>	600	v	
Gate-source voltage			V <sub>GS</sub>	± 30	V	
Continuous drain current (T, = 150 °C)	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	Ι <sub>D</sub>	6.4		
Continuous drain current $(1) = 150^{\circ}$ C)	VGS at 10 V	T <sub>C</sub> = 100 °C		4.0	А	
Pulsed drain current <sup>a</sup>	·		I <sub>DM</sub>	11		
Linear derating factor				0.5	W/°C	
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	9			
Maximum power dissipation		PD	62.5			
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope	purce voltage slope $T_J = 125 \text{ °C}$		alı . (alt	70	) //mm	
Reverse diode dv/dt <sup>d</sup>		dv/dt	17	V/ns		
Soldering recommendations (peak temperature)	С	For 10 s		260	°C	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>q</sub> = 25  $\Omega$ , I<sub>AS</sub> = 0.8 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D, \, di/dt$  = 100 A/µs, starting  $T_J$  = 25  $^\circ C$ 



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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.			UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-		62			°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-		2.0			0/10	
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 $^{\circ}$ C, t	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 2	250 μΑ	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_J$	Referenc	e to 25 °C,	I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}, I_D = 2$	250 µA	3.0	-	5.0	V
	1	$V_{GS} = \pm 20 V$		-	-	± 100	nA	
Gate-source leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30	V	-	-	± 1	μA
	1	V <sub>DS</sub> =	600 V, V <sub>G</sub>	<sub>S</sub> = 0 V	-	-	1	
Zero gate voltage drain current	IDSS	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	∕, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	١ <sub>c</sub>	<sub>0</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> =	= 20 V, I <sub>D</sub> =	= 2.0 A	-	1.2	-	S
Dynamic	•				•	•	•	•
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V		-	347	-	
Output capacitance	C <sub>oss</sub>	· ·	$V_{\rm DS} = 100$ V		-	24	-	
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	2	-	4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>		( to 400 )/		-	17	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	$v_{\rm DS} = 0$	/ to 480 V,	$v_{GS} = 0 v$	-	86	-	
Total gate charge	Qg				-	8	12	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_{\rm D} = 2.0$	A, V <sub>DS</sub> = 480 V	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>				-	3	-	
Turn-on delay time	t <sub>d(on)</sub>				-	12	24	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 2.0 A,		-	9	18		
Turn-off delay time	t <sub>d(off)</sub>		= 10 V, R <sub>g</sub> =		-	19	38	ns
Fall time	t <sub>f</sub>				-	22	44	
Gate input resistance	R <sub>g</sub>	f = 1 MHz, open drain		1.1	2.3	4.6	Ω	
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	۱ <sub>S</sub>	MOSFET sym showing the	bol		-	-	6.4	_
Pulsed diode forward current	I <sub>SM</sub>	integral revers p - n junction			-	-	11	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	, I <sub>S</sub> = 2.0 A	A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>				-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>		°C, $I_F = I_S$		-	1.0	2.0	μC
Reverse recovery current	I <sub>RRM</sub>	ai/at = 1	100 A/µs, \	/ <sub>R</sub> = ∠5 V	-	13	-	A
,		1			1		I	1

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



## SiHD690N60E

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

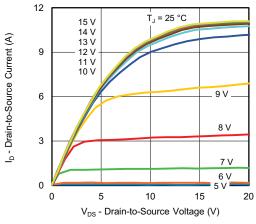


Fig. 1 - Typical Output Characteristics

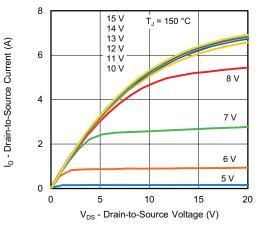


Fig. 2 - Typical Output Characteristics

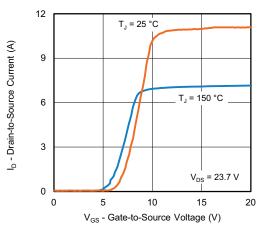


Fig. 3 - Typical Transfer Characteristics

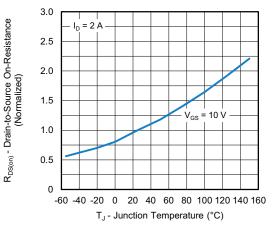


Fig. 4 - Normalized On-Resistance vs. Temperature

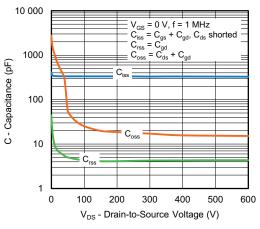


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

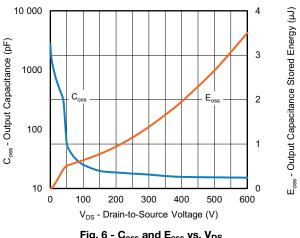


Fig. 6 - Coss and Eoss vs. VDS

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3 For technical questions, contact: hvm@vishay.com Document Number: 92273

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(2) (2)

Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

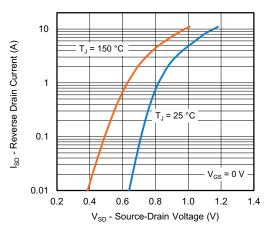


Fig. 8 - Typical Source-Drain Diode Forward Voltage

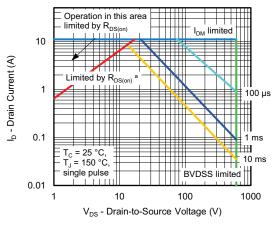


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

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4

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7

6

5

4

3 2

1

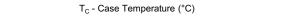
0

25

50

I<sub>D</sub> - Drain Current (A)

SiHD690N60E



100

125

150

75

Fig. 10 - Maximum Drain Current vs. Case Temperature

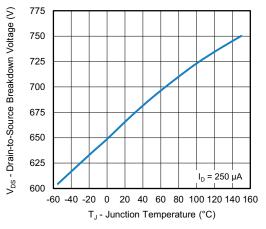


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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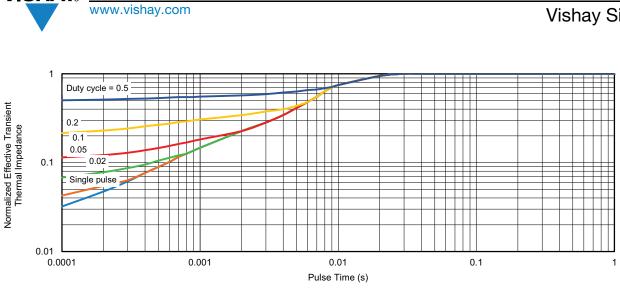


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

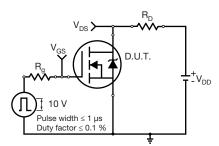


Fig. 13 - Switching Time Test Circuit

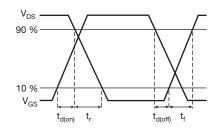


Fig. 14 - Switching Time Waveforms

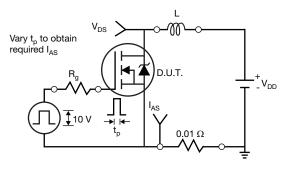


Fig. 15 - Unclamped Inductive Test Circuit

VDD V<sub>DS</sub>  $I_{AS}$ 

Fig. 16 - Unclamped Inductive Waveforms

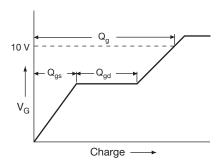


Fig. 17 - Basic Gate Charge Waveform

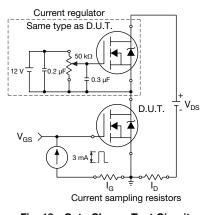


Fig. 18 - Gate Charge Test Circuit

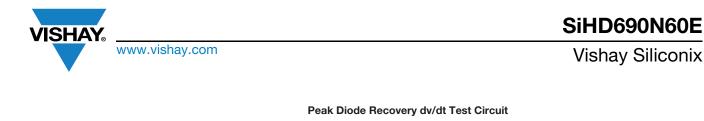
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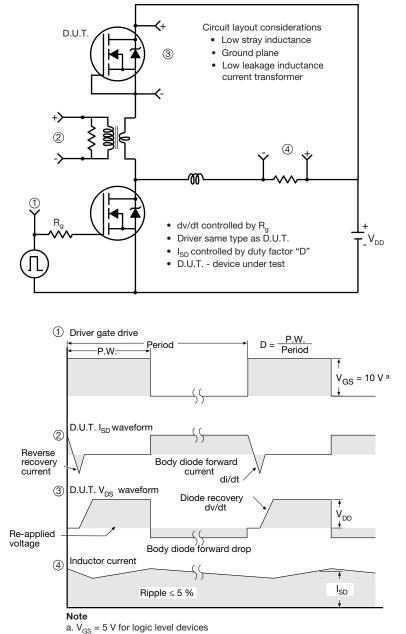


Fig. 19 - For N-Channel

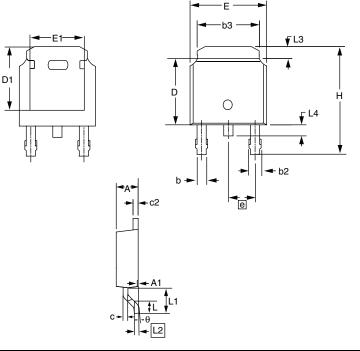
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# **Package Information**

**Vishay Siliconix** 

### **TO-252AA (HIGH VOLTAGE)**



	MILLI	METERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
E	6.40	6.73	0.252	0.265	
L	1.40	1.77	0.055	0.070	
L1	2.743 REF		0.108 REF		
L2	0.508	3 BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	
L4	0.64	1.01	0.025	0.040	
D	6.00	6.22	0.236	0.245	
Н	9.40	10.40	0.370	0.409	
b	0.64	0.88	0.025	0.035	
b2	0.77	1.14	0.030	0.045	
b3	5.21	5.46	0.205	0.215	
е	2.286	5 BSC	0.090 BSC		
А	2.20	2.38	0.087	0.094	
A1	0.00	0.13	0.000	0.005	
С	0.45	0.60	0.018	0.024	
c2	0.45	0.58	0.018	0.023	
D1	5.30	-	0.209	-	
E1	4.40	-	0.173	-	
θ	0'	10'	0'	10'	

Notes

1. Package body sizes exclude mold flash, protrusion or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 0.10 mm per side.

2. Package body sizes determined at the outermost extremes of the plastic body exclusive of mold flash, gate burrs and interlead flash, but including any mismatch between the top and bottom of the plastic body.

3. The package top may be smaller than the package bottom.

4. Dimension "b" does not include dambar protrusion. Allowable dambar protrusion shall be 0.10 mm total in excess of "b" dimension at maximum material condition. The dambar cannot be located on the lower radius of the foot.



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### **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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